

VPX3020 Series

Ruaged 3U VPX Intel[®] Xeon[®] and Core™ i3 Processor Blade

Features

- Intel® Xeon® Processor E-2254ML and 9th Gen Intel® Core™ i3 (formerly "Coffee Lake-H Refresh")
- DDR4-2666 soldered ECC SDRAM up to 16GB
- Up to 64GB SATA SLC SSD option
- Up to PCle x16 Gen3 interface supporting non-transparent bridge
- One XMC expansion slot, PCIe x8 Gen3 with Rear I/O to P2













Specifications

Processor & System

CPU

Intel® Xeon® Processor E-2254ML, 4 cores, 25W TDP Intel® Core™ i3-9100HL, 4 cores, 25W TDP (optional 6-core by request)

Chipset

Intel® CM246

Memory

Dual channel DDR4-2666 ECC soldered SDRAM, up to 16GB

BIOS

AMI EFI on 64Mbit SPI flash

VITA Standards

VITA 46.0 VPX Base Standard

VITA 46.4 PCI Express on VPX Fabric Connector

VITA 46.6 Gigabit Ethernet Control Plane on VPX

VITA 46.9 PMC/XMC/Ethernet Signal Mapping to 3U/6U VPX

VITA 46.10 Rear Transition Module on VPX

VITA 46.11 System Management on VPX

VITA 48.0 Ruggedized Enhanced Design Implementation Mechanical Base Specification

VITA 65 OpenVPX Architecture Framework for VPX

Connectivity

XMC

PCIe x8 Gen3 with Rear I/O (X8d+X12d) to P2 (or Two PCIe x4 Gen3 optional to P2)

1000BASE-T x1 & 1000BASE-BX x2 (or 1000BASE-T x2 optional)

Graphics

Intel® integrated GPU engine One DisplayPort to P2

USB 3.0 Full x1 (can be separated to 1x USB 3.0 & 1x USB 2.0)

Serial Ports

RS-232 x1 to P2

RS-232/422/485 x1 (or 4x GPIOs) to P2

GPIO

One GPIO to P1 (BOM option up to x6)

PCI Express

PCIe x8 Gen3, configurable to 1 x8 or 2 x4 to P1, supports DMA and non-transparent bridge for peer-to-peer communication

Storage

SLC NAND flash up to 64GB SATA 6Gb/s option, via add-on card One SATA 6Gb/s to P2



Specifications

• Security Mechanism

TPM

Atmel TPM version 2.0

IPMC

Smart Fusion A2F200 with VPX code base

OS Support

Wind River VxWorks 7.0
Microsoft Windows 10
Linux
(Please contact ADLINK for other OS support)

Miscellaneous

LEDs

System status LEDs on front and rear

Watchdog Timer

System reset or NMI with programmable interval

Reset Button

Reset button on front panel

• Mechanical & Environmental

Form Factor

Conduction cooled 3U VPX

Operating Temp.

Conduction cooled: -40°C to +85°C at wedge locks Air cooled: -40°C to +75°C at wedge locks

Storage Temp.

-50°C to +100°C

Relative Humidity

95% non-condensing

Shock

Sawtooth 40G, 11ms, each axis, operating

Vibration

5Hz-2KHz, 12Grms, random, each axis, operating

Thermal Dissipation

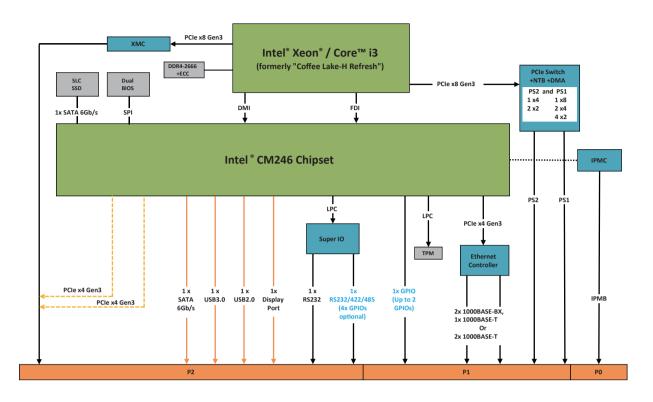
Convection and conduction

Safety & EMI

Certifications

CE, FCC Class A

VPX3020 Block Diagram



3U VPX Test Frame

Product Type 9-slot Test Frame Form Factor VPX 3U

Dimensions 142.6mm (H) x 209.9mm (W) x 276.28mm (D)

Blade Support Conduction cooled VPX 3U blades

Backplane Support 3-slot
RTM Support Yes
Cooling Passive fins
Power User define



3U VPX Test Frame

Ordering Information

Processor Blades

VPX3020/E2254/M16/S64/XMC-R1
 3U VPX processor board with Intel® Xeon® E2254ML, DDR4
 16GB, SLC 64GB, dual 1000BASE-T, DisplayPort, USB3.0/2.0,
 XMC slot with conformal coating & ETT -40°C to +85°C,
 conduction cooled

Rear Transition Modules

VPX-R3020
 RTM for VPX3020

Accessories

VPX-TF3090
 3U VPX conduction cooled test frame with tBP-VPX3000

